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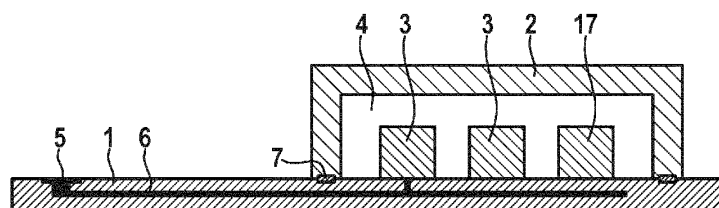


FIG. 1

(57) Abstract: The disclosure relates to an implant comprising a substrate (1), a housing (2), wherein the housing (2) is disposed on the substrate (1), an electronic circuit (3) disposed on the substrate (1) inside the housing (2), an electronic component (5) disposed on the substrate (1) outside the housing (2), and a conductor track (6), wherein the conductor track (6) connects the electronic circuit (3) to the electronic component (5). The conductor track (6) is embedded into the substrate (1) at least in sections in such a way that at least one section of the conductor track (6) is completely surrounded by the substrate (1). Furthermore, a method for creating an implant is disclosed.



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